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## Tag-it™ HF-I PRO TRANSPONDER INLAYS 24.2-mm CIRCULAR

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### FEATURES

- ISO/IEC 15693-2, -3; ISO/IEC 18000-3 Compliant
- 13.56-MHz Operating Frequency
- 256-Bit User Memory in 8-Bit × 32-Bit Blocks
- User and Factory Lock Per Block
- Application Family Identifier (AFI)
- Fast Simultaneous Identification (Anti-Collision)
- Password Protected Write Command

- Command to Disable IC Functionality

### APPLICATIONS

- Product Authentication
- Ticketing
- Stored Value

### DESCRIPTION

Texas Instruments Tag-it™ HF-I pro transponder inlays consist of 13.56-MHz high-frequency (HF) transponders that are compliant with the ISO/IEC 15693 and ISO/IEC 18000-3 global open standards. These products offer a user-accessible memory of 256 bits, organized in eight blocks, and an extended command set including password protect write available in five different antenna shapes, with frequency offset for integration into paper, PVC, or other substrates.

The Tag-it HF-I pro transponder inlays are manufactured with TI's patented laser tuning process to provide consistent read performance. Prior to delivery, the transponders undergo complete functional and parametric testing, in order to provide the high quality that customers have come to expect from TI.

The Tag-it HF-I pro transponder inlays are well suited for a variety of applications including, but not limited to, product authentication, library, supply-chain management, asset management, and ticketing/stored value applications.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Tag-it is a trademark of Texas Instruments.

**SPECIFICATIONS<sup>(1)</sup>**

	PART NUMBER
	RI-I16-114A-S1
Supported standard	ISO/IEC 15693-2, -3; ISO/IEC 18000-3
Recommended operating frequency	13.56 MHz
Passive resonance frequency (at 25°C)	13.70 MHz ± 400 kHz (includes frequency offset to compensate further integration into paper or PVC lamination)
Typical required activation field strength to read (at 25°C)	113 dBµA/m <sup>(2)</sup>
Typical required activation field strength to write (at 25°C)	116 dBµA/m <sup>(2)</sup>
Factory programmed read-only number	64 bits
Memory (user programmable)	256 bits organized in 8-bit × 32-bit blocks
Typical programming cycles (at 25°C)	100,000
Data retention time (at 55°C)	>10 years
Simultaneous identification of tags	Up to 50 tags per second (reader/antenna dependent)
Antenna size	∅ 24.2 mm +0.1 mm/–0.2 mm (~0.95 in)
Foil width	48 mm ± 0.5 mm (1.89 in ± 0.02 in)
Foil pitch	50.8 mm +0.1 mm/–0.4 mm (2 in)
Base material	Substrate: PET (polyethylenetherephthalate); Antenna: aluminum
Operating temperature	–25°C to 70°C
Storage temperature (single inlay)	–40°C to 85°C (warpage may occur at upper temperature range)
Storage temperature (on reel)	–40°C to 40°C
Delivery	Single-row tape wound on cardboard reel with 500-mm diameter Reel outer width: approximately 60 mm (~2.36 in) Reel inner width: approximately 50 mm (~1.97 in) Hub diameter: 76.2 mm (3 in)
Typical quantity of good units per reel	5,000

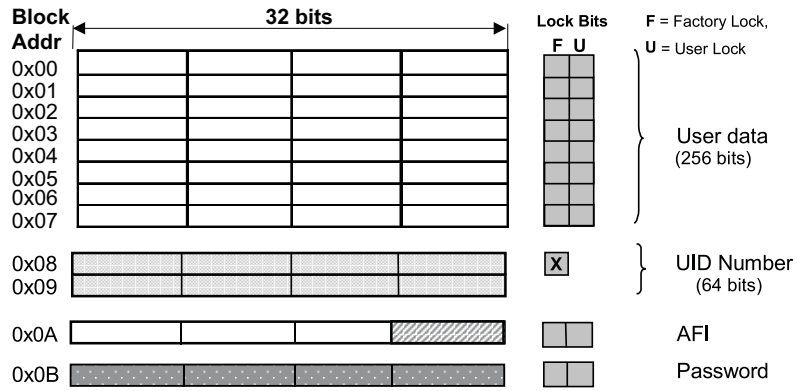
- (1) For highest possible read-out coverage, operate readers at a modulation depth of 20% or higher.
- (2) After integration into paper

**SUPPORTED COMMAND SET**

REQUEST	REQUEST MODE <sup>(1)</sup>					
	REQUEST CODE	INVENTORY	ADDRESSED	NON-ADDRESSED	AFI	OPT. FLAG
<b>ISO 15693 Mandatory and Optional Commands</b>						
Inventory	0x01	ü	–	–	ü	0/–
Stay Quiet	0x02	–	ü	–	–	0/–
Read_Single_Block	0x20	–	ü	ü	–	–/1
Write_Single_Block	0x21	–	ü	ü	–	–/1
Lock_Block	0x22	–	ü	ü	–	–/1
<b>TI Custom Commands</b>						
Kill	0xA4	–	ü	–	–	–/1
WriteSingleBlockPwd	0xA5	–	ü	–	–	–/1

- (1) ü = Implemented, – = Not applicable

**MEMORY ORGANIZATION**



**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
RI-116-114A-S1	ACTIVE	RFIDN	TFC	0	5000	Pb-Free (RoHS)	Call TI	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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